

LTCC SURFACE MOUNT

Bandpass Filter

50Ω

1500 to 1620 MHz

BFCN-1560+

THE BIG DEAL

- · Good Rejection, 30 dB Typ.
- 1206 Surface Mount Footprint
- Power Handling: 1.5 Watts

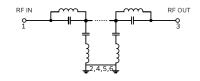


Generic photo used for illustration purposes only

APPLICATIONS

- · Harmonic Rejection
- · Transmitters / Receivers

FUNCTIONAL DIAGRAM



PRODUCT OVERVIEW

Mini-Circuits' BFCN-1560+ LTCC Band Pass Filter is constructed with multiple layers in order to achieve a miniature size and high repeatability of performance. Wrap-around terminations minimize variations in performance due to parasitics. Covering 120 MHz passband, these units offer low insertion loss and good rejection.

KEY FEATURES

Features	Advantages
Small Size, 1206	Allows for high layout density of circuit boards, while minimizing the effects of parasitics.
Wrap around termination	Provides excellent solderability and easy visual inspection capability.
LTCC construction	Provides a rugged package that is well suited for tough environments including high humidity and high temperature extremes.
Rugged Power handling	Handles up to 1.5 Watts in a small package.



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ELECTRICAL SPECIFICATIONS^{1,2} AT +25°C

Parameter		F#	Frequency (MHz)	Min.	Тур.	Max.	Units
	Center Frequency ³	_	_	_	1560	_	MHz
Passband	Insertion Loss	F1-F2	1500 - 1620	_	_	5	dB
	Return Loss	F1-F2	1500 - 1620	11.73	_	_	dB
Stan Band Lawer	Rejection	DC-F3	DC - 1040	_	30	_	dB
Stop Band, Lower		F4	1100	20	_	_	ив
Stop Band, Upper	Deignation	F5	2100	20	_	_	dB
	Rejection	F6-F7	2105 - 4200	_	30	_	uB

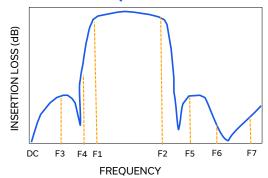
^{1.} Tested in Evaluation Board P/N TB-BFCN-1560+.

ABSOLUTE MAXIMUM RATINGS⁴

Parameter	Ratings
Operating Temperature	-55°C to 100°C
Storage Temperature	-55°C to 100°C
Input Power ⁵	1.5W @25°C

^{4.} Permanent damage may occur if any of these limits are exceeded.

TYPICAL FREQUENCY RESPONSE



^{2.} This component should not be used as a DC-block. In applications where DC voltage and/or current is present at either the input or output ports, external DC blocking capacitors are required.

^{3.} Typical variation ± 5%

^{5.} Power rating applies only to signals within the passband. Power rating above +25°C operating temperature decreases linearly to 0.25W at +100°C.

LTCC SURFACE MOUNT

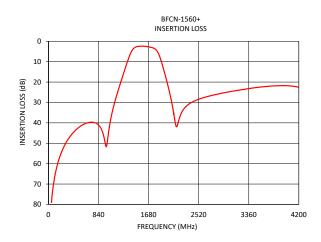
Bandpass Filter

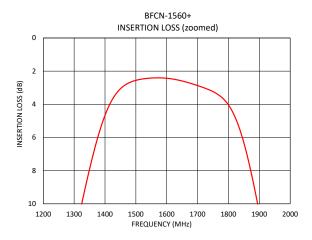
BFCN-1560+

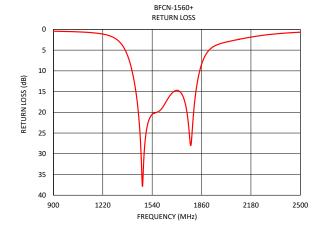
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TYPICAL PERFORMANCE GRAPHS AT +25°C









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FUNCTIONAL DIAGRAM

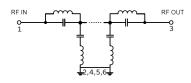
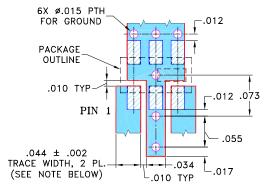


Figure 1. BFCN-1560+ Functional Diagram

PAD DESCRIPTION

Function	Pad Number	Description			
RF1 ²	1	Connects to RF Input Port			
RF2 ² 3		Connects to RF Output Port			
GROUND	2,4,5,6	Connects to Ground on PCB, (See drawing PL-158)			

SUGGESTED PCB LAYOUT (PL-158)



NOTE: 1. TRACE WIDTH IS SHOWN FOR ROGERS R04350B WITH DIELECTRIC THICKNESS .020" ± .0015".

COPPER: 1/2 OZ. EACH SIDE.
FOR OTHER MATERIALS TRACE WIDTH MAY NEED

FOR OTHER MATERIALS TRACE WIDTH MAY NEED TO BE MODIFIED.

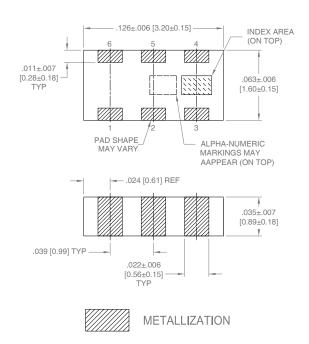
2. BOTTOM SIDE OF THE PCB IS CONTINUOUS GROUND PLANE.

DENOTES PCB COPPER LAYOUT WITH SMOBC (SOLDER MASK OVER BARE COPPER)

DENOTES COPPER LAND PATTERN FREE OF SOLDER MASK

Figure 2. Suggested PCB Layout PL-158

CASE STYLE DRAWING



Weight: .020 grams.

Dimensions are in inches (mm). Tolerances: 2Pl. ± .01; 3 Pl. ± .005

PRODUCT MARKING*: RS

*Marking may contain other features or characters for internal lot control.



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ADDITIONAL DETAILED INFORMATION IS AVAILABLE ON OUR DASH BOARD.

CLICK HERE

	Data
Performance Data & Graphs	Graphs
	S-Parameter (S2P Files) Data Set (.zip file) De-embedded to device pads
Case Style	FV1206-1 Lead Finish: Nickel Tin
RoHS Status	Compliant
Tape and Reel	TR-F75
Suggested Layout for PCB Design	PL-158
Evaluation Board	TB-BFCN-1560+
Evaluation board	Gerber File
Environmental Rating	ENV06

NOTES

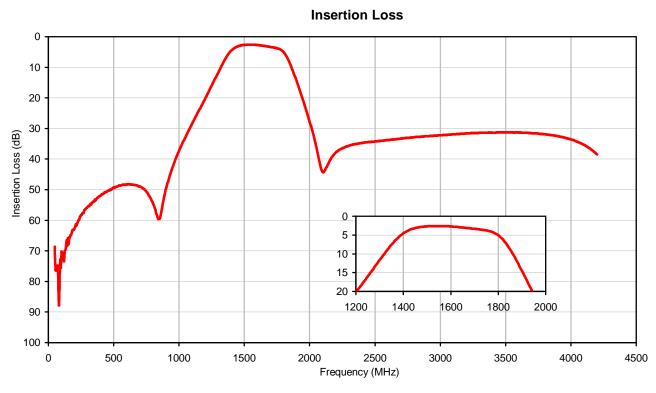
- A. Performance and quality attributes and conditions not expressly stated in this specification document are intended to be excluded and do not form a part of this specification document.
- B. Electrical specifications and performance data contained in this specification document are based on Mini-Circuits' applicable established test performance criteria and measurement instructions.
- C. The parts covered by this specification document are subject to Mini-Circuits' standard limited warranty and terms and conditions (collectively, "Standard Terms"); Purchasers of this part are entitled to the rights and benefits contained therein. For a full statement of the standard terms and the exclusive rights and remedies thereunder, please visit Mini-Circuits' website at www.minicircuits.com/terms/viewterm.html



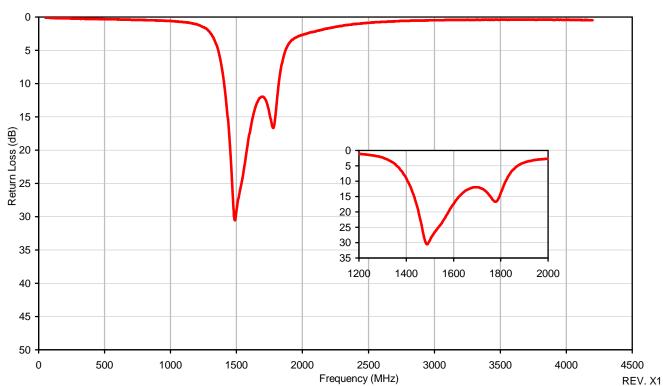
Typical Performance Data

FREQUENCY (MHz)	INSERTION LOSS (dB)	RETURN LOSS (dB)
50	68.59	0.09
200	62.54	0.19
500	49.47	0.33
1040	33.62	0.67
1100	28.46	0.76
1250	16.02	1.52
1340	8.35	3.76
1400	4.54	9.05
1500	2.69	29.20
1560	2.61	22.42
1620	2.81	15.30
1780	4.32	16.63
1850	8.81	6.45
1910	15.77	3.69
2000	27.69	2.67
2100	44.20	2.15
2105	44.37	2.11
3500	31.29	0.39
4200	38.45	0.49

Typical Performance Curves



Return Loss



Mini-Circuits®

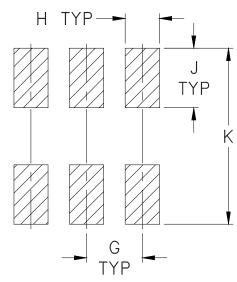
BFCN-1560+ 080219 Page 1 of 1

FV1206-1

Outline Dimensions

A±.006 INDEX AREA (ON TOP) F±.007 TYP B±.006 PAD SHAPE ALPHA-NUMERIC MARKINGS MAY APPEAR (ON TOP) C±.007 G TYP E±.006 TYP

PCB Land Pattern



Suggested Layout, Tolerance to be within ±.002

CASE #	A	В	С	D	Е	F	G	Н	J	K	L	M	N	P	WT. GRAM
FV1206-1	.126 (3.20)	.063 (1.60)	.035 (0.89)	.024 (0.61)	.022 (0.56)	.011 (0.28)	.039 (0.99)	.024 (0.61)	.042 (1.07)	.123 (3.12)	1 1	1 1			.020

Dimensions are in inches (mm). Tolerances: 2 Pl. + .01; 3 Pl. + .005

Notes:

- 1. Open style, ceramic base.
- 2. Termination finish: as shown below or indicated on Data Sheet.

For RoHS Case Styles: Tin plate over Nickel plate. All models, (+) suffix.

For RoHS-5 Case Styles: Tin-Lead plate. All models, no (+) suffix.





P.O. Box 350166, Brooklyn, New York 11235-0003 (718) 934-4500 Fax (718) 332-4661 For detailed performance specs & shopping online see Mini-Circuits web site

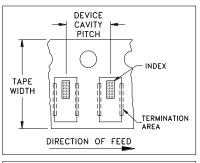
The Design Engineers Search Engine Provides ACTUAL Data Instantly From MINI-CIRCUITS At: www.minicircuits.com

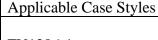
RF/IF MICROWAVE COMPONENTS

Tape & Reel Packaging

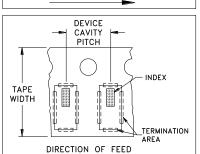
TR-F75

DEVICE ORIENTATION IN T&R

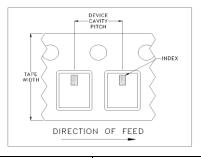




FV1206-1 FV1206-3



Applicable Case Styles
FV1206-4
FV1206-5
FV1206-6
FV1206-7
FV1206-9



Applicabl	e Case Styles
FV1206-1	12
GE0805C	C-18
NL1008C	2-6
NL1008C	2-7
NL1008C	:-9
NL1008C	C-10

ILLUSTRATION 3

ILLUSTRATION 1

ILLUSTRATION 2

Tape Width, mm	Device Cavity Pitch, mm	Reel Size, inches	Devices p	oer Reel
			Small	20
			quantity	50
			standards	100
8	4	7	(see note)	200
				500
				1000
			Standard	3000

Note: Please consult individual model data sheet to determine device per reel availability.

Mini-Circuits carrier tape materials provide protection from ESD (Electro-Static Discharge) during handling and transportation. Tapes are static dissipative and comply with industry standards EIA-481/EIA-541.

Go to: www.minicircuits.com/pages/pdfs/tape.pdf

Mini-Circuits ISO 9001 & ISO 14001 Certified



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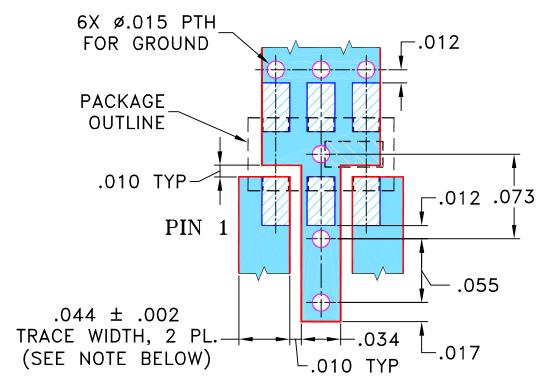
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THIRD	ANGLE	PROJECT	ION
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		REVISIONS			
REV	ECN No.	DESCRIPTION	DATE	DR	AUTH
OR	M92199	NEW RELEASE	05/24/04	ΑV	ABD
A	M99247	ADD GROUND PTH	06/05	RZ	RZ
A	R60782	ADD GROUND PTH	06/05	RZ	RZ
В	M102713	ADDED "WITH SMOBC"	01/12/06	GF	IL

SUGGESTED MOUNTING CONFIGURATION FOR FV1206-1 CASE STYLE, "pr" PIN CONNECTION.



NOTE: 1. TRACE WIDTH IS SHOWN FOR ROGERS RO4350B WITH DIELECTRIC THICKNESS .020" ± .0015". COPPER: 1/2 OZ. EACH SIDE. FOR OTHER MATERIALS TRACE WIDTH MAY NEED TO BE MODIFIED.

2. BOTTOM SIDE OF THE PCB IS CONTINUOUS GROUND PLANE.



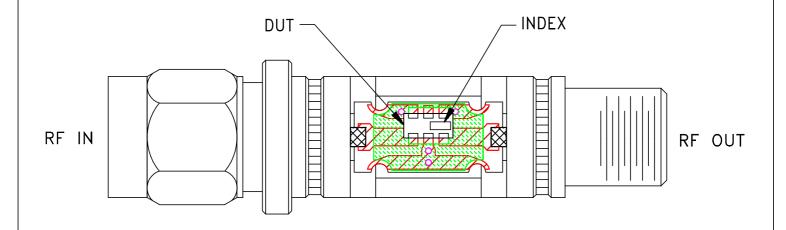
DENOTES PCB COPPER LAYOUT WITH SMOBC (SOLDER MASK OVER BARE COPPER)



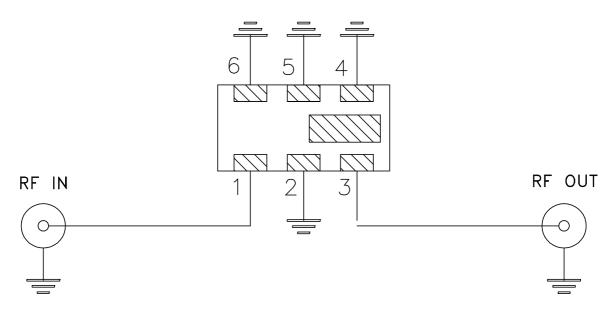
DENOTES COPPER LAND PATTERN FREE OF SOLDER MASK

UNLESS OTHERWISE SPECIFIED INITIALS		DATE								
DIMENSIONS ARE IN INCHES	DRAWN	AV	05/03/04	Mini-Circuits® 13 Neptune Avenue Brooklyn NY 11235						
TOLERANCES ON: 2 PL DECIMALS ±	CHECKED	IL	05/24/04		Brooklyn NI 11235					
3 PL DECIMALS ± .005	APPROVED	ABD	05/24/04							
FRACTIONS ±				ceil PL	PL, pr, FV1206-1, HFCN, TB-285					
⊞ Mini−Circuits ®										
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				A	15542		98-PL-158 E			
				FILE: (98PL158	SCALE:	12:1	SHEET:	1	OF 1
	ASHEETA1.D	WG REV:A D	ATE:01/12/95	<u> </u>	OI LIOU		1~.1			

Evaluation Board and Circuit



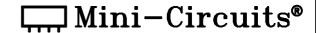
TB-285



Schematic Diagram

Notes:

- 1. SMA Female connectors.
- 2. PCB Material: Rogers RO4350 or equivalent, Dielectric Constant=3.5, Thickness=.020 inch.





Environmental Specifications

ENV06

All Mini-Circuits products are manufactured under exacting quality assurance and control standards, and are capable of meeting published specifications after being subjected to any or all of the following physical and environmental test.

Specification	Test/Inspection Condition	Reference/Spec			
Operating Temperature	-55° to 100°C Ambient Environment	Individual Model Data Sheet			
Storage Temperature	-55° to 100° C Ambient Environment	Individual Model Data Sheet			
Humidity	90 to 95% RH, 240 hours, 50°C	MIL-STD-202, Method 103, Condition A, Except 50°C and end-point electrical test done within 12 hours			
Solder Reflow Heat	Sn-Pb Eutetic Process: 225°C peak Pb-Free Process 245° - 250°C peak	J-STD-020, Table 4-1, 4-2 and 5-2, Figure 5-1			
Solderability	10X Magnification	J-STD-002, Para 4.2.5, Test S, 95% Coverage			
Vibration (High Frequency)	20g peak, 10-2000 Hz, 12 times in each of three perpendicular directions (total 36)	MIL-STD-202, Method 204, Condition D			
Mechanical Shock	50g, 11 ms, 1/2-sine, 18 shocks: 3 each direction, each of 3 axes	MIL-STD-202, Method 213, Condition A			

ENV06 Rev: A

02/25/11

M130240 File: ENV06.pdf